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1-to-64 Bit Variable Length **Shift Register**

The MC14557B is a static clocked serial shift register whose length may be programmed to be any number of bits between 1 and 64. The number of bits selected is equal to the sum of the subscripts of the enabled Length Control inputs (L1, L2, L4, L8, L16, and L32) plus one. Serial data may be selected from the A or B data inputs with the A/B select input. This feature is useful for recirculation purposes. A Clock Enable (CE) input is provided to allow gating of the clock or negative edge clocking capability.

The device can be effectively used for variable digital delay lines or simply to implement odd length shift registers.

- 1-64 Bit Programmable Length
- Q and \overline{Q} Serial Buffered Outputs
- Asynchronous Master Reset
- All Inputs Buffered
- No Limit On Clock Rise and Fall Times
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low-power TTL Loads or one Low-power Schottky TTL Load Over the Rated Temperature Range
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage Range	-0.5 to +18.0	V
V _{in} , V _{out}	Input or Output Voltage Range (DC or Transient)	-0.5 to V _{DD} + 0.5	V
I _{in} , I _{out}	Input or Output Current (DC or Transient) per Pin	±10	mA
P _D	Power Dissipation, per Package (Note 2)	500	mW
T _A	Ambient Temperature Range	-55 to +125	°C
T _{stg}	Storage Temperature Range	-65 to +150	°C
T _L	Lead Temperature (8–Second Soldering)	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- 1. V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.
- 2. Temperature Derating: Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C



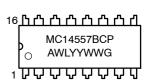
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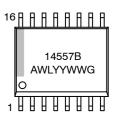






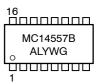


SO-16 WB DW SUFFIX CASE 751G





SOEIAJ-16 **F SUFFIX CASE 966**



= Assembly Location

WL. L = Wafer Lot YY, Y = Year WW, W = Work Week = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

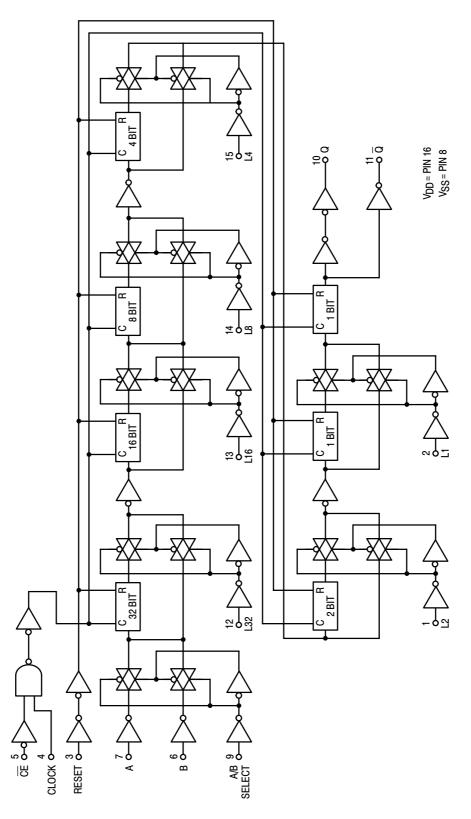


Figure 1. Logic Diagram

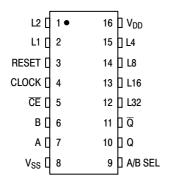


Figure 2. Pin Assignment

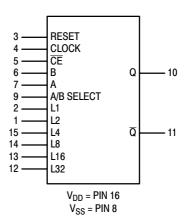


Figure 3. Block Diagram

TRUTH TABLE

	Output			
Rst	A/B	Clock	CE	Q
0	0	_	0	В
0	1	_	0	Α
0	0	1	7	В
0	1	1	7	Α
1	Х	Х	X	0

Q is the output of the first selected shift register stage.
X = Don't Care

LENGTH SELECT TRUTH TABLE

L32	L16	L8	L4	L2	L1	Register Length
0	0	0	0	0	0	1 Bit
0	0	0	0	0	1	2 Bits
0	0	0	0	1	0	3 Bits
0	0	0	0	1	1	4 Bits
0	0	0	1	0	0	5 Bits
0	0	0	1	0	1	6 Bits
•	•	•	•	•	•	•
•	•	•	•	•	•	•
•	•	•	•	•	•	•
1	0	0	0	0	0	33 Bits
1	0	0	0	0	1	34 Bits
•	•	•	•	•	•	•
•	•	•	•	•	•	•
•	•	•	•	•	•	•
1	1	1	1	0	0	61 Bits
1	1	1	1	0	1	62 Bits
1	1	1	1	1	0	63 Bits
1	1	1	1	1	1	64 Bits

NOTE: Length equals the sum of the binary length control subscripts plus one.

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

				- 55°C 25°C			125	125°C			
Symbol	Characteristic		V _{DD} Vdc	Min	Max	Min	Typ (Note 3)	Max	Min	Max	Unit
V _{OL}	Output Voltage V _{in} = V _{DD} or 0	"0" Level	5.0 10 15	- - -	0.05 0.05 0.05	- - -	0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
V _{OH}	V _{in} = 0 or V _{DD}	"1" Level	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95	- - -	Vdc
V _{IL}	Input Voltage (V _O = 4.5 or 0.5 Vdc) (V _O = 9.0 or 1.0 Vdc) (V _O = 13.5 or 1.5 Vdc)	"0" Level	5.0 10 15	- - -	1.5 3.0 4.0	- - -	2.25 4.50 6.75	1.5 3.0 4.0	- - -	1.5 3.0 4.0	Vdc
V _{IH}	$(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	5.0 10 15	3.5 7.0 11	- - -	3.5 7.0 11	2.75 5.50 8.25	- - -	3.5 7.0 11	- - -	Vdc
I _{OH}	Output Drive Current (V _{OH} = 2.5 Vdc) (V _{OH} = 4.6 Vdc) (V _{OH} = 9.5 Vdc) (V _{OH} = 13.5 Vdc)	Source	5.0 5.0 10 15	-3.0 -0.64 -1.6 -4.2	- - - -	-2.4 -0.51 -1.3 -3.4	-4.2 -0.88 -2.25 -8.8	- - - -	-1.7 -0.36 -0.9 -2.4	- - - -	mAdc
I _{OL}	$(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	Sink	5.0 10 15	0.64 1.6 4.2	- - -	0.51 1.3 3.4	0.88 2.25 8.8	- - -	0.36 0.9 2.4	- - -	
l _{in}	Input Current		15	-	±0.1	-	±0.00001	±0.1	-	±1.0	μAdc
C _{in}	Input Capacitance (V _{in} = 0)		-	-	-	-	5.0	7.5	-	-	pF
I _{DD}	Quiescent Current (Per Package)		5.0 10 15	- - -	5.0 10 20	- - -	0.010 0.020 0.030	5.0 10 20	- - -	150 300 600	μAdc
I _T	Total Supply Current (Notes 4, 5) (Dynamic plus Quiescent, Per Packa (C _L = 50 pF on all outputs, all buffers		5.0 10 15			$I_{T} = (3$.75 μA/kHz) .50 μA/kHz) .25 μA/kHz)	f + I _{DD}	•	•	μAdc

Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
 The formulas given are for the typical characteristics only at 25°C.
 To calculate total supply current at loads other than 50 pF: I_T(C_L) = I_T(50 pF) + (C_L – 50) Vfk where: I_T is in μA (per package), C_L in pF, V = (V_{DD} – V_{SS}) in volts, f in kHz is input frequency, and k = 0.001.

SWITCHING CHARACTERISTICS (Note 6) ($C_L = 50 \text{ pF}, T_A = 25^{\circ}\text{C}$)

Symbol	Characteristic	V _{DD}	Min	Typ (Note 7)	Max	Unit
t _{TLH} ,	Rise and Fall Time, Q or Q Output					ns
t _{THL}	t_{TLH} , $t_{THL} = (1.5 \text{ ns/pF}) C_L + 25 \text{ ns}$	5	_	100	200	
	t_{TLH} , $t_{THL} = (0.75 \text{ ns/pF}) C_L + 12.5 \text{ ns}$	10	_	50	100	
	t_{TLH} , $t_{THL} = (0.55 \text{ ns/pF}) C_L + 9.5 \text{ ns}$	15	_	40	80	
t _{PLH} ,	Propagation Delay, Clock or CE to Q or Q					ns
t _{PHL}	t _{PLH} , t _{PHL} = (1.7 ns/pF) C _L + 215 ns	5	_	300	600	
	t_{PLH} , $t_{PHL} = (0.66 \text{ ns/pF}) C_L + 97 \text{ ns}$	10	_	130	260	
	t_{PLH} , $t_{PHL} = (0.5 \text{ ns/pF}) C_L + 65 \text{ ns}$	15	_	90	180	
t _{PLH} ,	Propagation Delay, Reset to Q or Q					ns
t _{PHL}	t_{PLH} , $t_{PHL} = (1.7 \text{ ns/pF}) C_L + 215 \text{ ns}$	5	_	300	600	
	t_{PLH} , $t_{PHL} = (0.66 \text{ ns/pF}) C_L + 97 \text{ ns}$	10	_	130	260	
	t_{PLH} , $t_{PHL} = (0.5 \text{ ns/pF}) C_L + 70 \text{ ns}$	15	_	95	190	
t _{WH(cl)}	Pulse Width, Clock	5	200	95	_	ns
-vvn(ci)		10	100	45	_	
		15	75	35	_	
t _{WH(rst)} Pu	Pulse Width, Reset	5	300	150	_	ns
	1 4.55 111411, 115551	10	140	70	_	
		15	100	50	_	
f _{cl} Clock F	Clock Frequency (50% Duty Cycle)	5	_	3.0	1.7	MHz
	Sicon requestoy (50% Buty Cycle)	10	_	7.5	5.0	1
		15	_	13.0	6.7	
t _{su}	Setup Time, A or B to Clock or CE					ns
ou	Worst case condition: L1 = L2 = L4 = L8 =	5	700	350	_	
	L16 = L32 = V _{SS} (Register Length = 1)	10	290	130	_	
		15	145	85	_	
	Best case condition: L32 = V _{DD} , L1 through L16 =	5	400	45	_	
	Don't Care (Any register length from 33 to 64)	10	165	5	_	
	, , , , , ,	15	60	0	_	
t _h	Hold Time, Clock or CE to A or B					ns
	Best case condition: L1 = L2 = L4 = L8 = L16 =	5	200	-150	_	
	L32 = V _{SS} (Register Length = 1)	10	100	-60	_	
	35 (3)	15	10	-50	_	
	Worst case condition: L32 = V _{DD} , L1 through L16 =	5	400	50	-	
	Don't Care (Any register length from 33 to 64)	10	185	25	_	
		15	85	22	_	
t _r ,	Rise and Fall Time, Clock	5		•		_
t _f	·	10		No Limit		
		15				
t _r ,	Rise and Fall Time, Reset or CE	5	_	_	15	μS
t _f	,	10	_	_	5	
		15	_	_	4	
t _{rem}	Removal Time, Reset to Clock or CE	5	160	80	_	ns
16111		10	80	40	_	
		1	70	_	1	1

^{6.} The formulas given are for the typical characteristics only at 25°C.
7. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

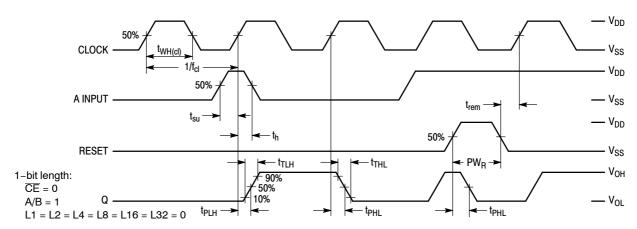


Figure 4. Timing Diagram

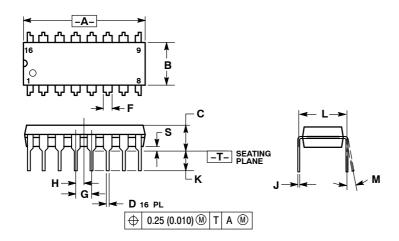
ORDERING INFORMATION

Device	Package	Shipping [†]
MC14557BFELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel
MC14557BDWR2G	SO-16 (WB)	1000 / Tape & Reel
MC14557BCPG	PDIP-16 (Pb-Free)	500 Units / Rail
MC14557BDWG	SO-16 (WB)	47 Units / Rail

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

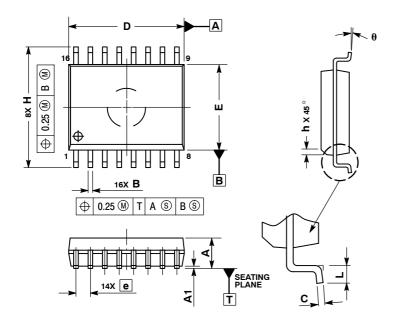
PDIP-16 **P SUFFIX** CASE 648-08 **ISSUE T**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. DIMENSION B DOES NOT INCLUDE
- MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27	BSC	
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
М	0°	10 °	0°	10 °	
S	0.020	0.040	0.51	1.01	

SO-16 WB DW SUFFIX CASE 751G-03 **ISSUE C**



- NOTES:
 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 3. DIMENSIONS D AND E DO NOT INLCUDE MOLD PROTRUSION.

- MOLD PHOTHUSION.

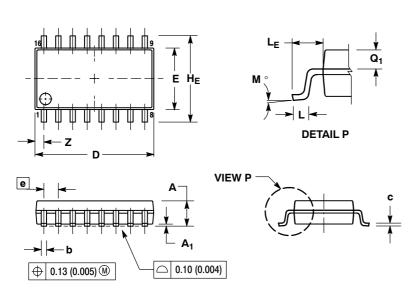
 4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

 5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS				
DIM	MIN	MAX			
Α	2.35	2.65			
A1	0.10	0.25			
В	0.35	0.49			
С	0.23	0.32			
D	10.15	10.45			
Е	7.40	7.60			
е	1.27	BSC			
Н	10.05	10.55			
h	0.25	0.75			
J	0.50	0.90			
a	0 °	7 °			

PACKAGE DIMENSIONS

SOEIAJ-16 CASE 966-01 ISSUE A



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
- 2. DONTHOLDING DIMILIFORM. MILLIMIT LIT.

 3. DIMENSIONS D AND E DO NOT INCLUDE
 MOLD FLASH OR PROTRUSIONS AND ARE
 MEASURED AT THE PARTING LINE. MOLD FLASH
 OR PROTRUSIONS SHALL NOT EXCEED 0.15
 (0.006) PER SIDE.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
C	0.10	0.20	0.007	0.011
D	9.90	10.50	0.390	0.413
Е	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050 BSC	
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0 °	10°	0 °	10°
Q_1	0.70	0.90	0.028	0.035
Z		0.78		0.031

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